TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC7MBD3245AFK

#### Octal Bus Switch

The TC7MBD3245AFK provides eight bits of high-speed TTL-compatible bus switching in a standard '245 device pinout. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

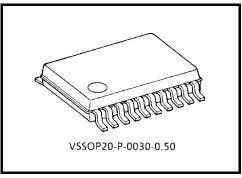
The device is organized as one 8-bit switch. When output enable  $(\overline{OE})$  is low, the switch is on and port A is connected to port B. When  $\overline{OE}$  is high, the switch is open and a high-impedance state exists between the two ports.

The device is enable to realize the shift of signal level from  $5~\mathrm{V}$  to  $3.3~\mathrm{V}$ .

All inputs are equipped with protection circuits against static discharge.

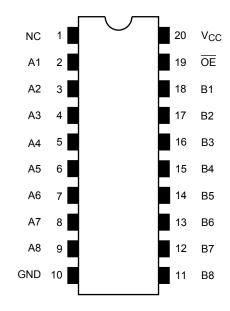


- Operating voltage:  $V_{CC} = 4.5 \sim 5.5 \text{ V}$
- High speed:  $t_{pd} = 0.32 \text{ ns (max)}$
- Low on resistance:  $RON = 5 \Omega$  (typ.)
- ESD performance: Machine model  $\geq \pm 200~V$ Human body model  $\geq \pm 2000~V$
- Compatible with TTL outputs (control inputs)
- Low Power Dissipation: Icc =  $10 \mu A (max.)$
- Package: VSSOP (US20)
- Pin compatible with the 74xx245 type.
- Functionally equivalent to (FST/CBT) 3245.



Weight: 0.03 g (typ.)

## Pin Assignment (top view)

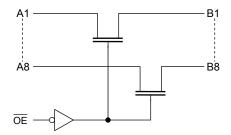


NC-No Internal Connection

#### **Truth Table**

Inputs	Function		
ŌĒ	T dilettori		
L	A port = B port		
Н	Disconnect		

## **System Diagram**



## **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Power supply range	V <sub>CC</sub>	-0.5~7.0	V
DC input voltage	V <sub>IN</sub>	-0.5~7.0	V
DC switch voltage	Vs	-0.5~7.0	V
Input diode current	I <sub>IK</sub>	-50	mA
Continuous channel circuit	IS	128	mA
Power dissipation	P <sub>D</sub>	180	mW
DC V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	<b>−65~150</b>	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	4.5~5.5	V
Input voltage	V <sub>IN</sub>	0~5.5	V
Switch voltage	Vs	0~5.5	V
Operating temperature	T <sub>opr</sub>	-40~85	°C
Input rise and fall time	dt/dv	0~10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.



## **Electrical Characteristics**

# DC Characteristics ( $Ta = -40 \sim 85$ °C)

Charac	teristics	Symbol	Test Condition V <sub>CC</sub>		V <sub>CC</sub> (V)	Min	Typ. (Note 1)	Max	Unit
Input voltage	"H" level	V <sub>IH</sub>	_	-	4.5~5.5	2.0	_	_	V
Input voltage	"L" level	V <sub>IL</sub>	_	-	4.5~5.5	_	_	0.8	V
High lovel outp	ut voltage		IOH = -1 μA V <sub>IS</sub> = V <sub>CC</sub>		4.75	2.3	2.8	3.2	V
High-level outp	(Note 2)	VoH			5.0	2.5	3.0	3.4	
	(14016-2)		VIS - VCC		5.25	2.7	3.2	3.6	
Input leakage of	current	I <sub>IN</sub>	V <sub>IN</sub> = 0~5.5 V		4.5~5.5	_	_	±1.0	μА
Power off leaka	age current	I <sub>OFF</sub>	A, B, $\overline{OE}$ = 0~5.5 V		0	_	_	±1.0	μА
Off-STATE leal (switch off)	kage current	I <sub>SZ</sub>	A, B = 0~5.5 V, $\overline{OE} = V_{CC}$		4.5~5.5	_	_	±1.0	μА
ON resistance (Note 3)	Ron	V <sub>IS</sub> = 0 V	I <sub>IS</sub> = 64 mA	4.5	_	5	9		
				4.75	_	5	8	Ω	
				4.5	_	5	9		
				4.75	_	5	8		
			۸	4.5	_	35	65		
		VIS - 2.5 V, IIS - 15 IIIA		4.75	_	35	50		
Quiescent supp	oly current	ICC	VIN = VCC or GND,I <sub>OUT</sub> = 0		5.5	_	_	10	μА
Increase in I <sub>CC</sub>	per input	Δl <sub>CC</sub>	V <sub>IN</sub> = 3.4 V (one input)		5.5	_	_	2.5	mA

Note 1: Typical values are at  $V_{CC} = 5 \text{ V}$ ,  $Ta = 25^{\circ}C$ .

Note 2: It recommends that this device uses Pull-up resistance when adding and using resistance for an output terminal. Since it couses to drop a VOH voltage level when using Pull-down resistance for an output terminal.

Note 3: Measured by the voltage drop between A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

# AC Characteristics ( $Ta = -40 \sim 85$ °C)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Propagation delay time (bus to bus)	t <sub>pLH</sub>	Figure 1, Figure 2 (Note)	4.5	_	0.32	ns
Output enable time	t <sub>pZL</sub>	Figure 1, Figure 3	4.5	l	7.0	ns
Output disable time	t <sub>pLZ</sub>	Figure 1, Figure 3	4.5		7.0	ns

Note: The propagation delay time is calculated by the RC (on-resistance and load capacitance) time constant.

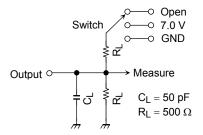
# **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Control pin input capacitance	C <sub>IN</sub>	(Note)	5.0	3	pF
Switch terminal capacitance	C <sub>I/O</sub>	$\overline{OE} = V_{CC}$ (Note)	5.0	10	pF

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Note: This parameter is guaranteed by design.

## **AC Test Circuit**



Parameter	Switch		
t <sub>pLH</sub> , t <sub>pHL</sub>	Open		
t <sub>pLZ</sub> , t <sub>pZL</sub>	7.0 V		
$t_{pHZ}$ , $t_{pZH}$	GND		

Figure 1

## **AC Waveform**

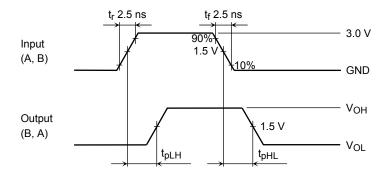


Figure 2 t<sub>pLH</sub>, t<sub>pHL</sub>

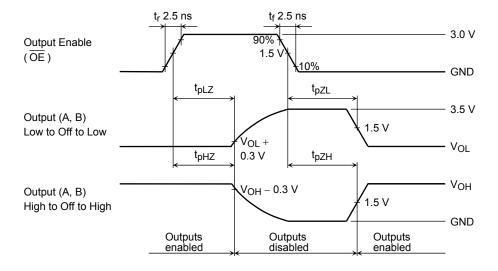
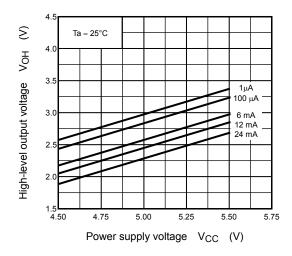
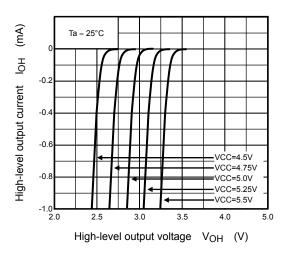
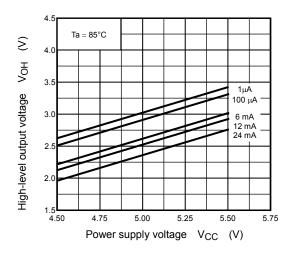


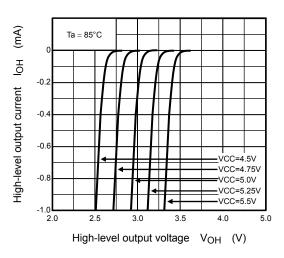
Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$ 

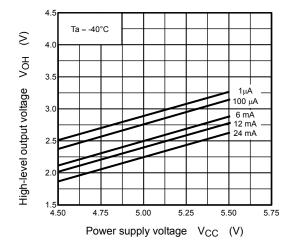
# **V<sub>OH</sub> – V<sub>CC</sub> Characteristics** (typ.)











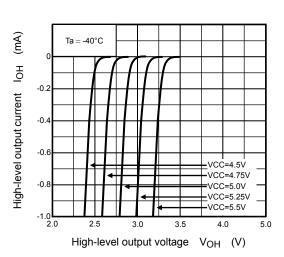
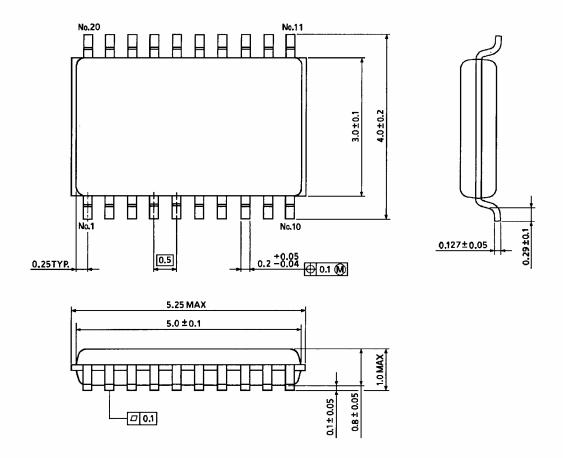


Figure 4

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# **Package Dimensions**



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Weight: 0.03 g (typ.)

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20070701-EN GENERAL

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